

TOSHIBA Fast Recovery Diode Silicon Diffused Type

S5295B, S5295G, S5295J

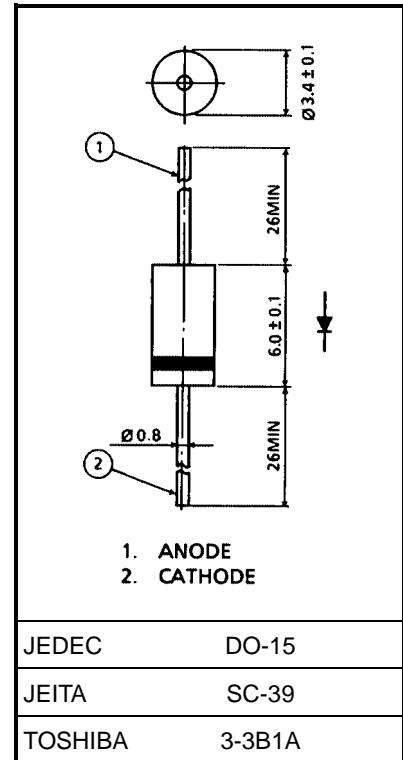
High Speed Rectifier Applications (fast recovery)

Unit: mm

- Average Forward Current: $I_F (AV) = 0.5 \text{ A}$ ($T_a = 50^\circ\text{C}$)
- Repetitive Peak Reverse Voltage: $V_{RRM} = 100, 400, 600 \text{ V}$
- Reverse Recovery Time: $1.5 \mu\text{s}$
- Plastic Mold Type.

Maximum Ratings

Characteristics		Symbol	Rating	Unit
Repetitive peak reverse voltage	S5295B	V_{RRM}	100	V
	S5295G		400	
	S5295J		600	
Reverse voltage (DC)	S5295B	V_R	75	V
	S5295G		300	
	S5295J		500	
Average forward current ($T_a = 50^\circ\text{C}$)		$I_F (AV)$	0.5	A
Peak one cycle surge forward current (non repetitive)		I_{FSM}	30 (50 Hz)	A
			33 (60 Hz)	
Junction temperature		T_j	-40 to 125	$^\circ\text{C}$
Storage temperature range		T_{stg}	-40 to 125	$^\circ\text{C}$



Weight: 0.42 g (typ.)

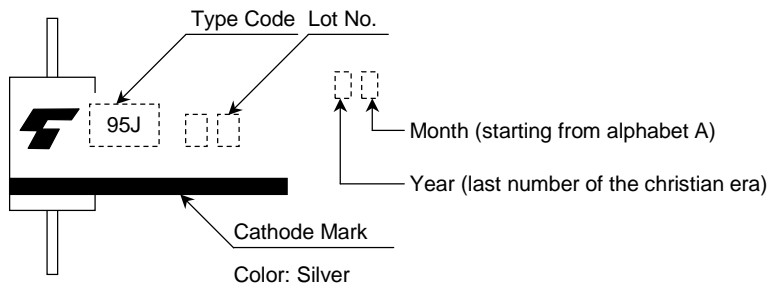
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	V_{FM}	$I_{FM} = 1.0 \text{ A}$	—	—	1.5	V
Repetitive peak reverse current	I_{RRM}	$V_{RRM} = \text{Rated}$	—	—	10	μA
Reverse recovery time	t_{rr}	$I_F = 20 \text{ mA}, I_R = 1 \text{ mA}$	—	—	1.5	μs
Forward recovery voltage	V_{fr}	$I_F = 100 \text{ mA}, t_r = 100 \text{ ns}, t_w = 5 \mu\text{s}$	—	—	10	V

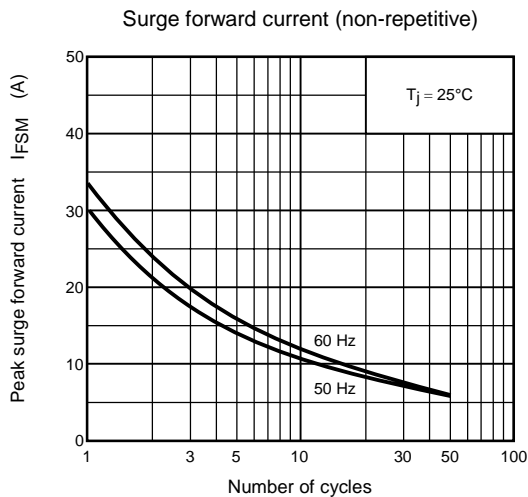
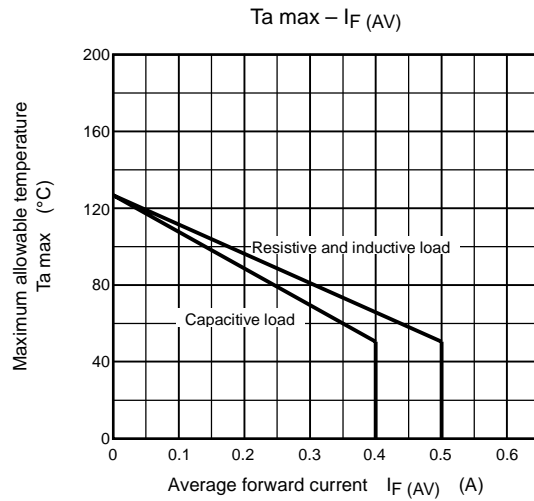
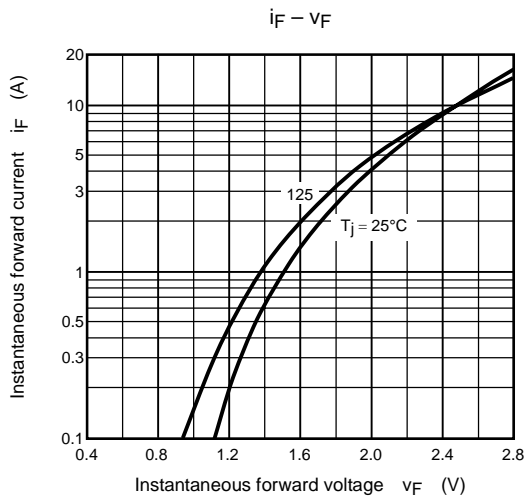
Note1: Soldering: 5 mm is the minimum to be kept between case and soldering part.

Note2: Lead bending: 5 mm is the minimum to be kept from the case when bend the lead wire.

Marking



Code	Type
95B	S5295B
95G	S5295G
95J	S5295J



RESTRICTIONS ON PRODUCT USE

000707EAA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.